

# New Carrier Glass Technology with Bonding Layer (for Ultra-Thin Glass)

[Web Site Link](#)

## ▶ 應用 Applications

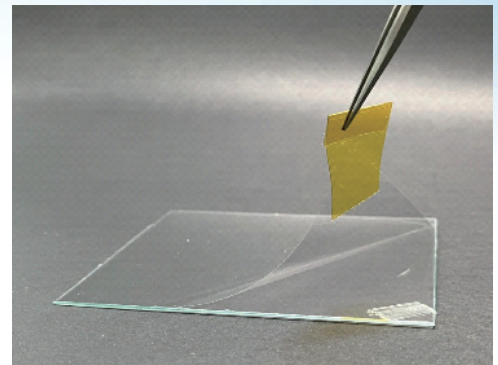
- Flexible/Thinner Sensor Device  
可撓式/薄型感應裝置
- Flexible/Thinner Transparent Display  
可撓式/薄型透明顯示器

## ▶ 特點 Features

- 1 Easy handling of UTG (Ultra-Thin Glass)  
易於操作使用超薄玻璃
- 2 Applicable for MLO  
可用於機械剝離
- 3 High heat resistance of Bonding Layer  
高耐熱性的黏著層
- 4 Large size available  
可對應大尺寸

\* Thickness of UTG is under 100µm.  
超薄玻璃的厚度僅不到100µm.

【MLO (Mechanical Lift Off)】



## ▶ 技術資料 Technical Data

【Process】

